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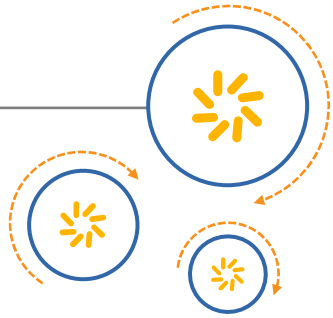

SAW components

SAW RF filter

Automotive telematics
GLONASS L

Series/type:	B3421
Ordering code:	B39152B3421U410
Date:	September 18, 2017
Version:	2.2

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RF360 Europe GmbH, Anzinger Str. 13, München, Germany

SAW components **B3421**

SAW RF filter **1542.0 MHz**

Data sheet

Table of contents

1 Application

- Low loss RF filter for GLONASS L band application
- Unbalance to Unbalance operation
- Usable pass band 34 MHz
- No matching required for operation at 50 Ω

2 Features

- Package size 3.0±0.1 mm × 3.0±0.1 mm
- Package height 1.1±0.125 mm
- Package code DCC6C
- Approximate weight 0.04 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Lead free soldering compatible with J-STD20C
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 1 (MSL1)
- AEC-Q200 qualified component family (Grade 1: −40 °C to +125 °C)

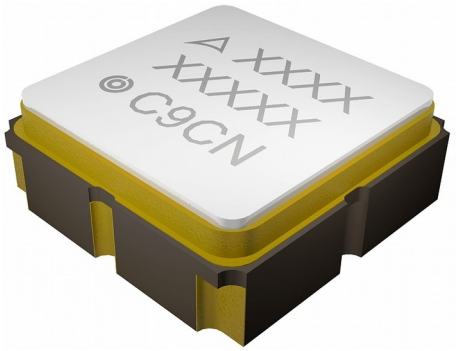


Figure 1: Picture of component with example of product marking.

3 Package

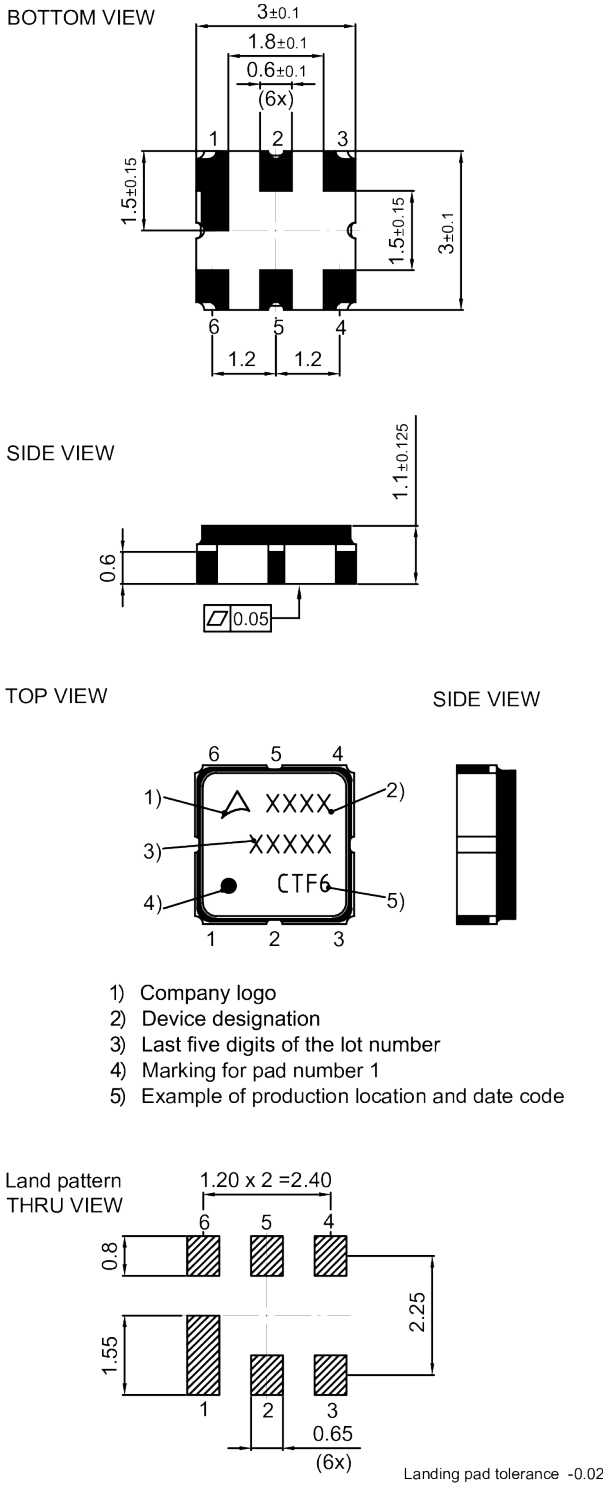


Figure 2: Drawing of package. See Sec. Package information (p. 18).

4 Pin configuration

- 2 Input
- 5 Output
- 1, 3, 4, 6 Ground

5 Matching circuit

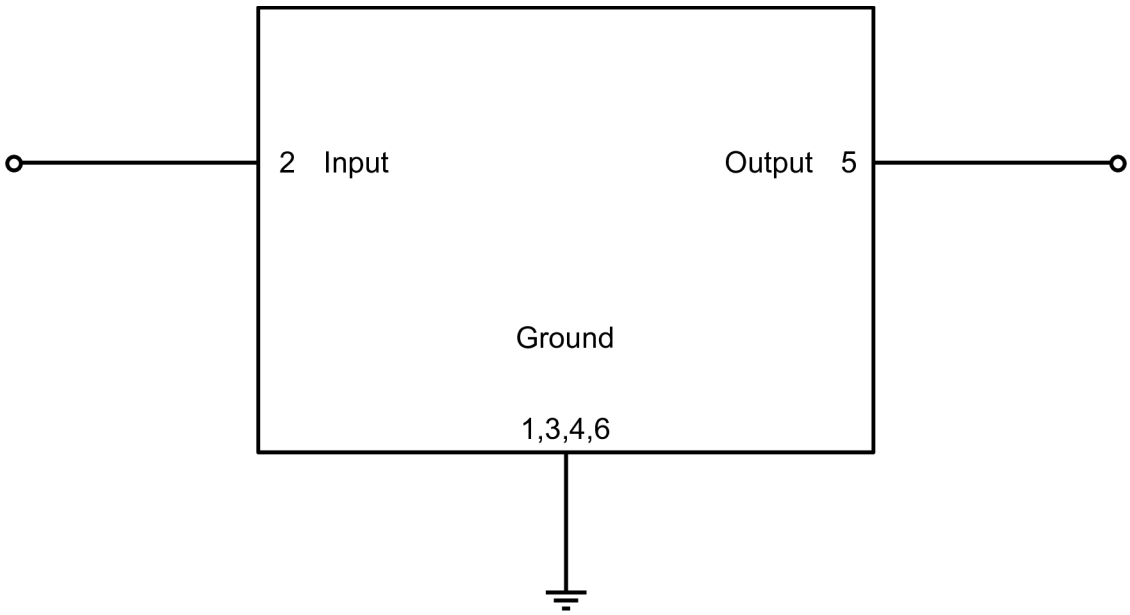


Figure 3: Schematic of matching circuit. No external matching components required.

6 Characteristics

Temperature range for specification T_{SPEC} = −40 °C ... +105 °C
Input terminating impedance Z_{IN} = 50 Ω
Output terminating impedance Z_{OUT} = 50 Ω

Characteristics				min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency			f_C	—	1542	—	MHz
Maximum insertion attenuation			α_{max}				
	1525... 1559	MHz		—	1.4	3.0	dB
Amplitude ripple (p-p)			$\Delta\alpha$				
	1525... 1559	MHz		—	0.4	2.0	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	1525... 1559	MHz		—	1.4	1.9	
@ output port	1525... 1559	MHz		—	1.4	1.9	
Minimum attenuation			α_{min}				
	50... 1000	MHz		45	54	—	dB
	1000... 1463	MHz		30	40	—	dB
	1610... 2000	MHz		30	40	—	dB
	2000... 3000	MHz		30	35	—	dB
Group delay ripple[1)]			$\Delta\tau_{var}$				
	1525... 1559	MHz		—	5.0	15	ns

1) Aperture 2.0 MHz.

7 Maximum ratings

Operable temperature	T_{OP} = −45 °C ... +125 °C	
Storage temperature	T_{STG} [1)] = −45 °C ... +125 °C	
DC voltage	$\|V_{DC}\|$ = 6.0 V	
Input power @ input port: 1525 ... 1559 MHz	P_{IN} = 19 dBm	Continuous wave for 5000 h @ 55 °C.

1) Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.

8 Transmission coefficient

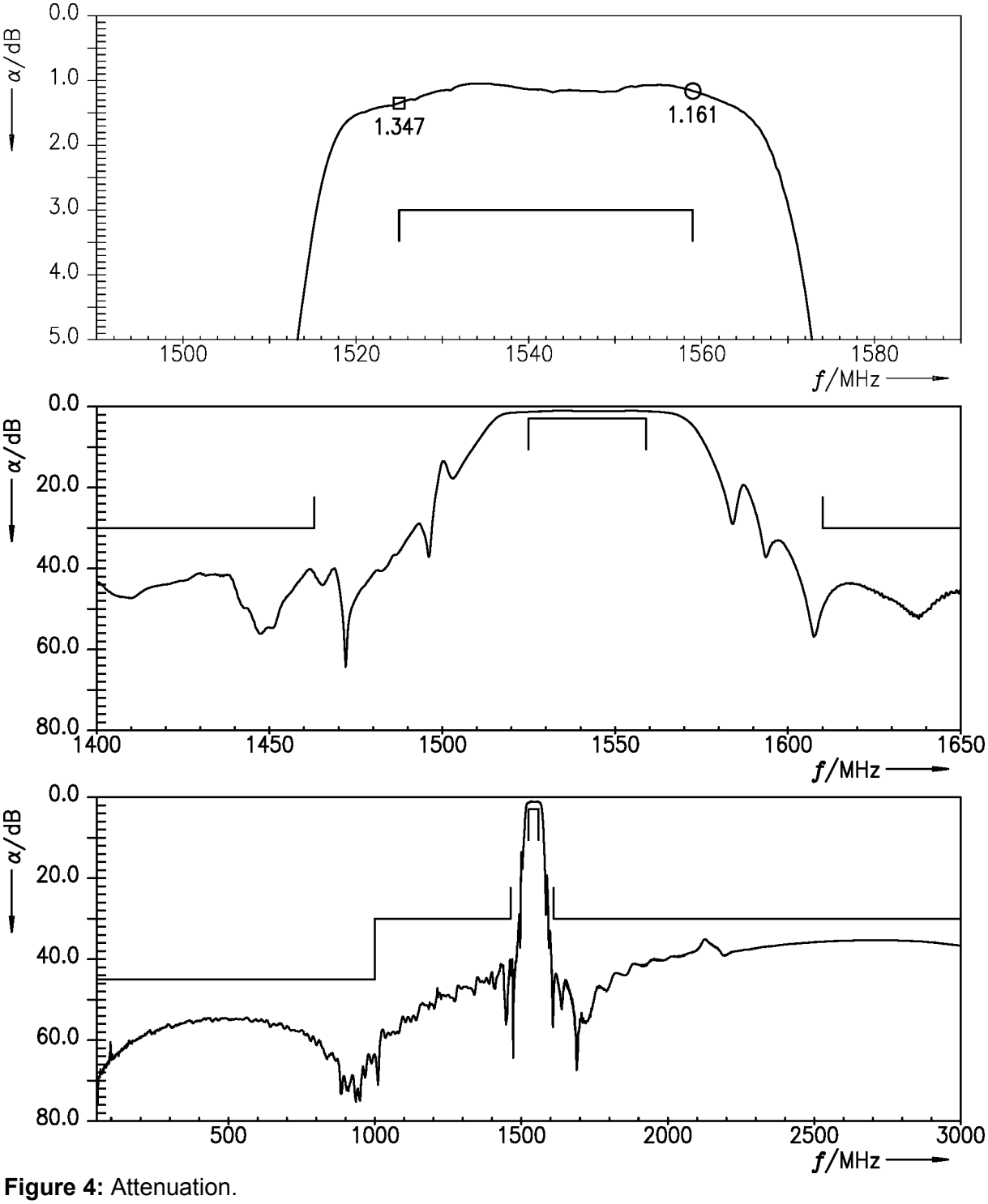


Figure 4: Attenuation.

9 Reflection coefficients

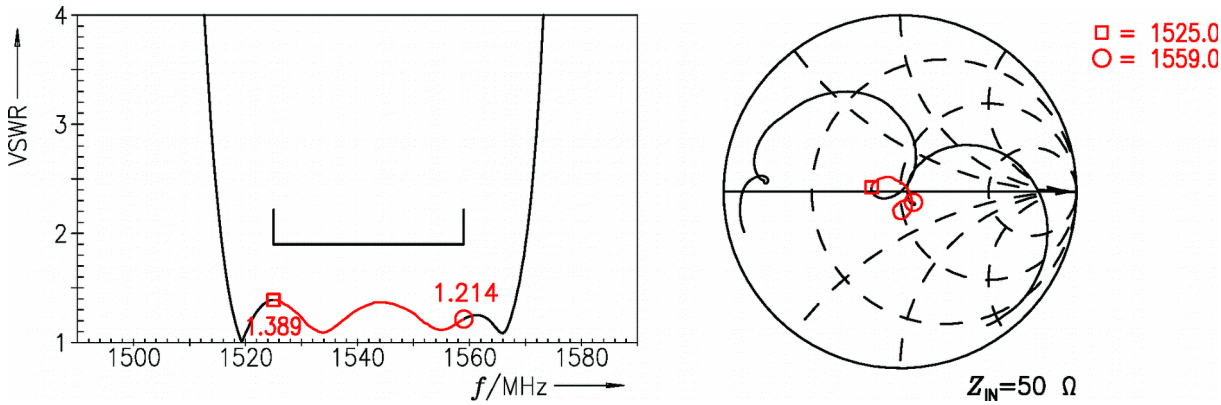


Figure 5: Reflection coefficient at IN port.

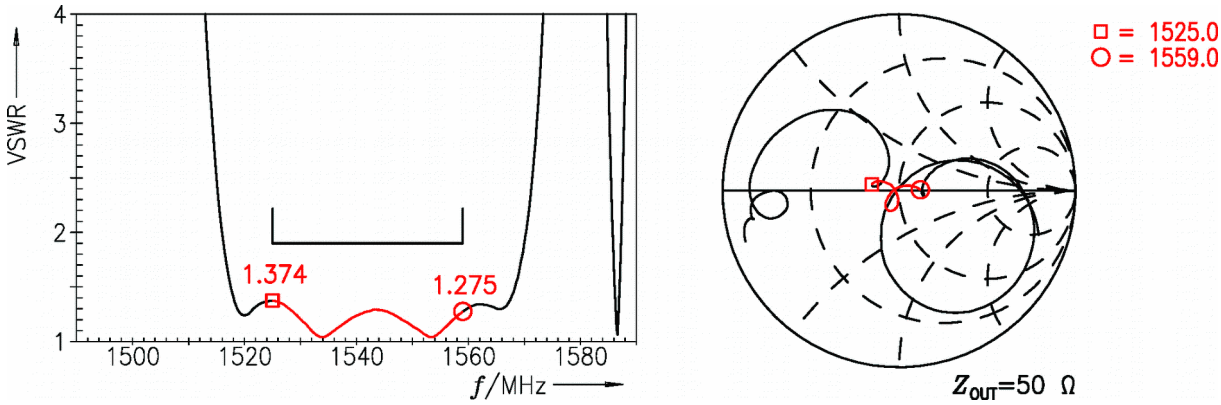


Figure 6: Reflection coefficient at OUT port.

10 Group delay

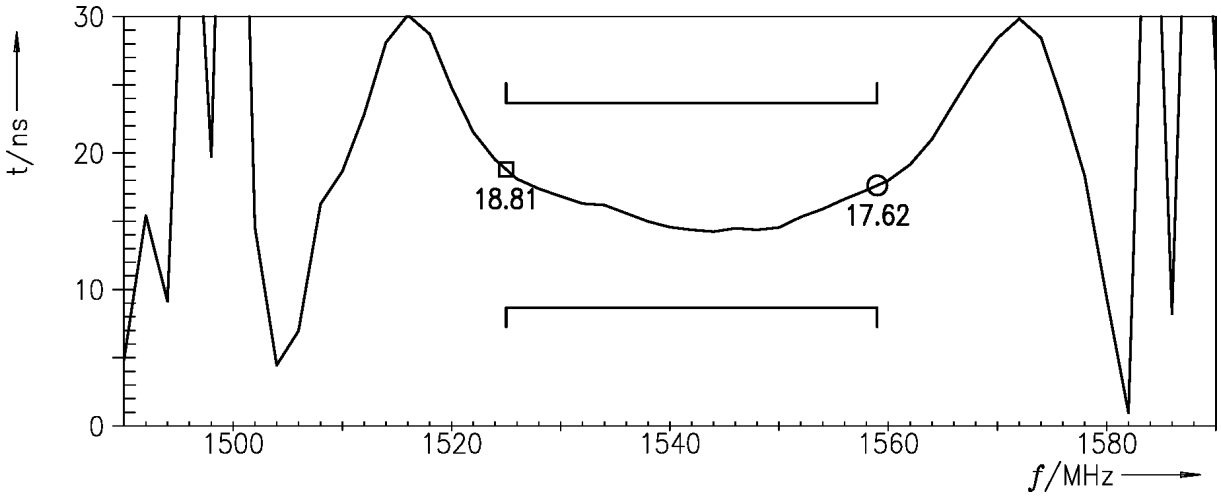


Figure 7: Group delay ripple.

11 Packing material

11.1 Tape

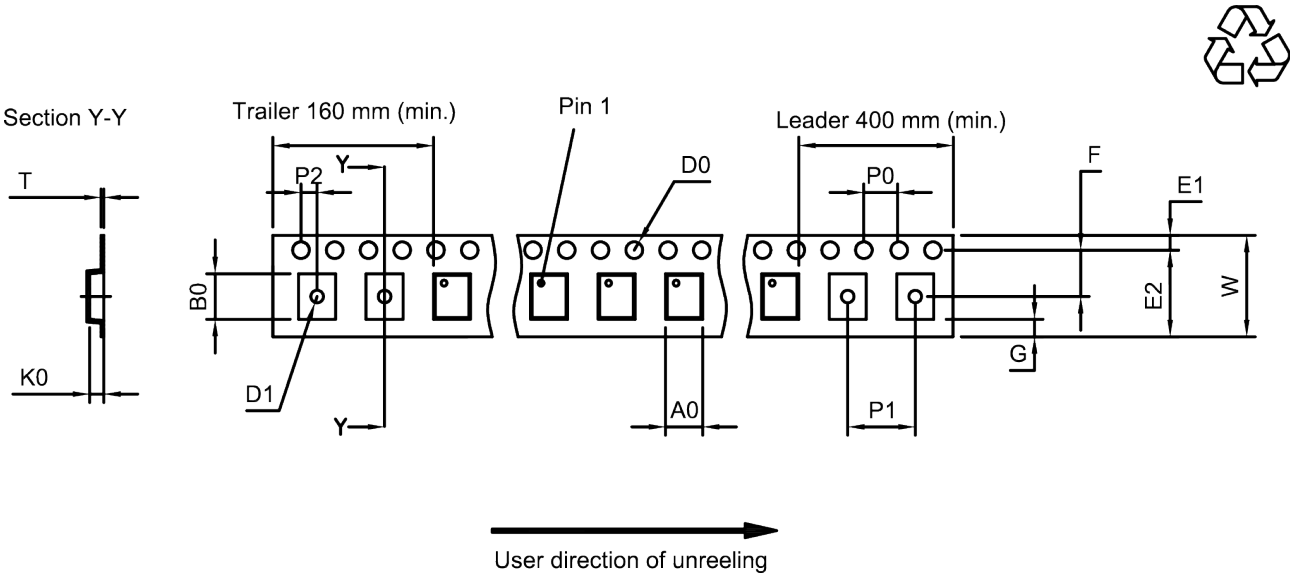


Figure 8: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A_0	3.25±0.1 mm
B_0	3.3±0.1 mm
D_0	1.5+0.1/−0 mm
D_1	1.5 mm (min.)
E_1	1.75±0.1 mm

E_2	10.25 mm (min.)
F	5.5±0.05 mm
G	0.75 mm (min.)
K_0	1.5±0.1 mm
P_0	4.0±0.1 mm

P_1	4.0±0.1 mm
P_2	2.0±0.1 mm
T	0.2±0.05 mm
W	12.0+0.3/−0.1 mm

Table 1: Tape dimensions.

11.2 Reel with diameter of 330 mm

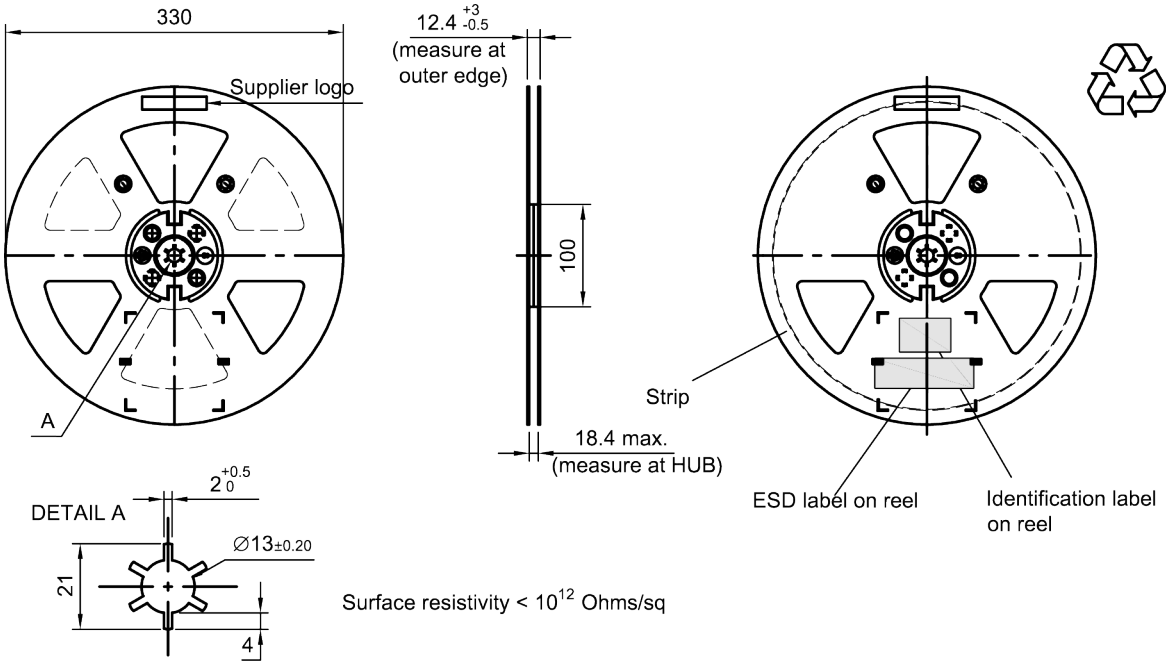
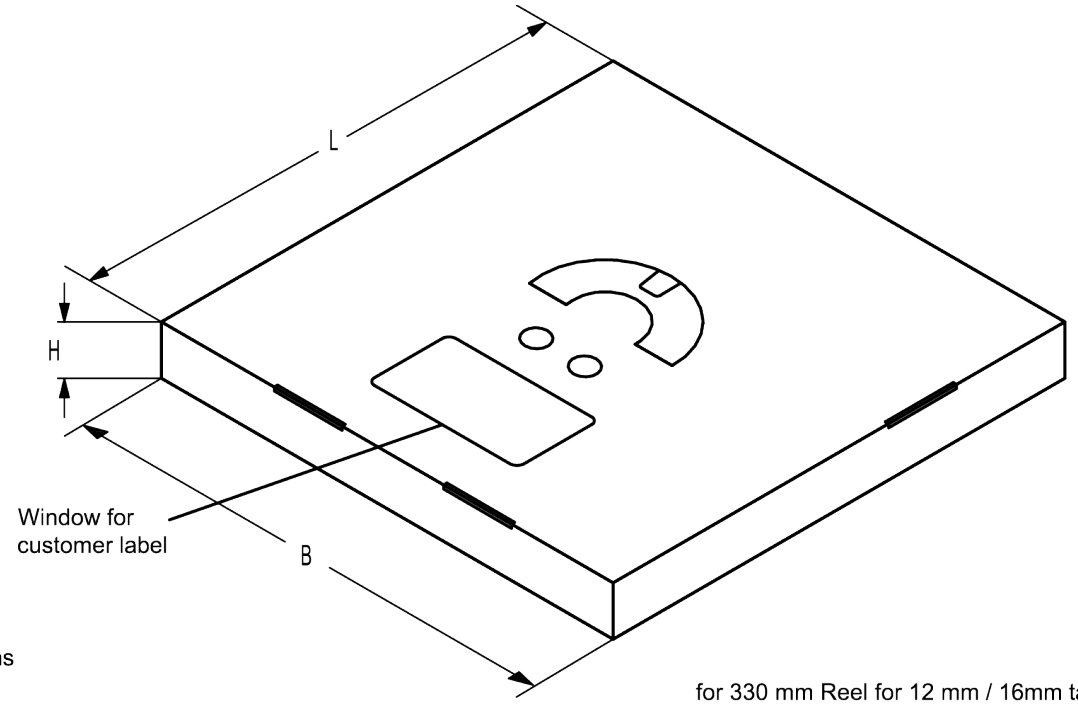


Figure 9: Drawing of reel (first-angle projection) with diameter of 330 mm.



Dimensions

L = 340
B = 340
H = 25

for 330 mm Reel for 12 mm / 16mm tape width SMD packages

Figure 10: Drawing of folding box for reel with diameter of 330 mm.

12 Marking

Products are marked with device designation, lot number, as well as production location and date code.

- Device designation: The 4-character device designation of the ordering code is used for the marking.

  Example for 4-character device designation: B3xxxxB**1234**xxxx

- Lot number: The last 5 digits of the lot number are used for the marking.

  Example: **12345**

- Production location and date code: The production location is Wuxi (encoded in the first character 'C'). The production date code is encoded in the last three characters according to Table 2.

1st digit (day)					
Day	Code	Day	Code	Day	Code
1	1	11	A	21	M
2	2	12	B	22	N
3	3	13	C	23	P
4	4	14	D	24	R
5	5	15	E	25	S
6	6	16	F	26	T
7	7	17	H	27	U
8	8	18	J	28	V
9	9	19	K	29	W
10	0	20	L	30	X
				31	Z

2nd digit (year)			
Year	Code	Year	Code
2010	A	2022	P
2011	B	2023	R
2012	C	2024	S
2013	D	2025	T
2014	E	2026	U
2015	F	2027	V
2016	H	2028	W
2017	J	2029	X
2018	K	2030	Z
2019	L	2031	A
2020	M	2032	B
2021	N	and so on	

3rd digit (month)			
Month	Code	Month	Code
Jan	1	Jul	7
Feb	2	Aug	8
Mar	3	Sep	9
Apr	4	Oct	0
May	5	Nov	N
Jun	6	Dec	D

Table 2: Production date code.

Example of how to decode production location and date code:

Code: **C T F 6**

Location: C → Wuxi

Day: T → 26th

Year: F → 2015

Month: 6 → June

13 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
T ≥ 255 °C	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

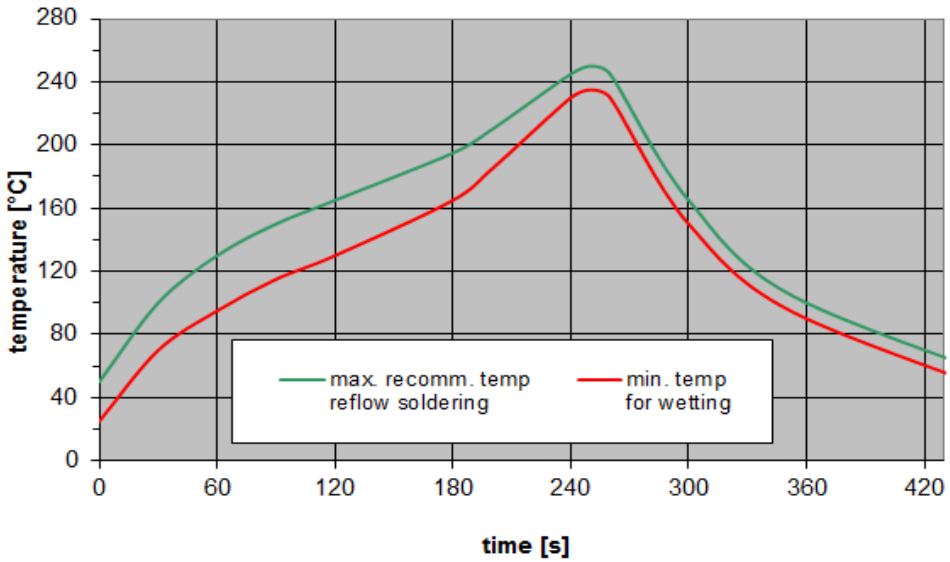


Figure 11: Recommended reflow profile for convection and infrared soldering – lead-free solder.

14 ESD protection of SAW filters

SAW filters are **E**lectro **S**tatic **D**ischarge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, “ESD matching” has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore, only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended “ESD matching” topologies.

For wide band filters the high-pass ESD matching structure needs to be at least of 3rd order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.

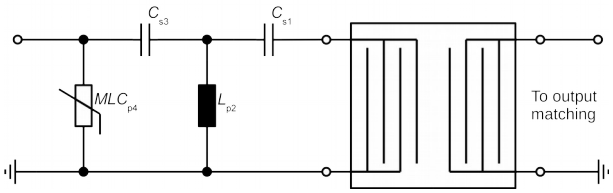


Figure 12: MLC varistor plus ESD matching.

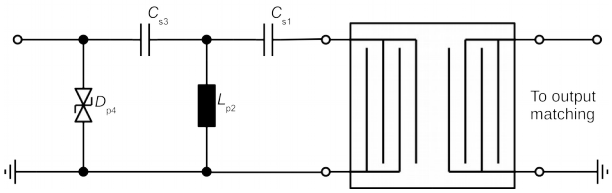


Figure 13: Suppressor diode plus ESD matching.

In cases where minor ESD occur, following simplified “ESD matching” topologies can be used alternatively.

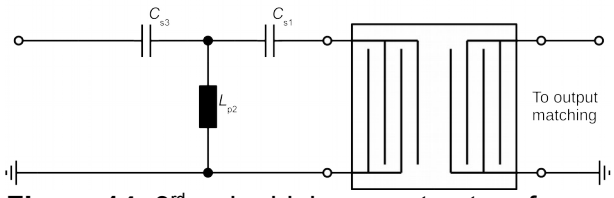


Figure 14: 3rd order high-pass structure for basic ESD protection.

In all three figures the shunt inductor L_{p2} could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available PCB space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements.

For further information, please refer to RF360 Application report: **“ESD protection for SAW filters”.** This report can be found under www.rf360jv.com/rke. Click on “Applications Notes”.

15 Annotations

15.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

15.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

15.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

16 Cautions and warnings

16.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

16.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

16.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

16.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.** As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified.** In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
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